# International **ICR** Rectifier

# **AUIRF3205**

#### Features

- Advanced Planar Technology
- Low On-Resistance
- Dynamic dV/dT Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified\*

#### **Description**

Specifically designed for Automotive applications, this Stripe Planar design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.



| HEXFEI | • Power | MOSFEI |
|--------|---------|--------|
|        |         |        |

|   | V <sub>(BR)DSS</sub>     | 55V           |
|---|--------------------------|---------------|
|   | R <sub>DS(on)</sub> max. | <b>8.0m</b> Ω |
| s | ID (Silicon Limited)     | <b>110A</b> ⑤ |
|   | ID (Package Limited)     | 75A           |



### **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T<sub>a</sub>) is 25°C, unless otherwise specified.

|   | Parameter   | Max.               | Units |
|---|---|--------------------|-------|
| I <sub>D</sub> @ T <sub>C</sub> = 25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V (Silicon Limited) | 110 <sup>⑤</sup>   |       |
| I <sub>D</sub> @ T <sub>C</sub> = 100°C | Continuous Drain Current, V <sub>GS</sub> @ 10V (Silicon Limited) | 80③                | А     |
| I <sub>D</sub> @ T <sub>C</sub> = 25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V (Package Limited) | 75                 |       |
| I <sub>DM</sub>                         | Pulsed Drain Current ①  | 390                |       |
| P <sub>D</sub> @T <sub>C</sub> = 25°C   | Power Dissipation   | 200                | W     |
|   | Linear Derating Factor  | 1.3                | W/°C  |
| V <sub>GS</sub>                         | Gate-to-Source Voltage  | ± 20               | V     |
| E <sub>AS</sub>                         | Single Pulse Avalanche Energy (Thermally Limited) <sup>②</sup>    | <b>264</b> ⑦       | mJ    |
| I <sub>AR</sub>                         | Avalanche Current ①   | 62                 | А     |
| E <sub>AR</sub>                         | Repetitive Avalanche Energy 0 6                                   | 20                 | mJ    |
| TJ                                      | Operating Junction and  | -55 to + 175       |       |
| T <sub>STG</sub>                        | Storage Temperature Range   |                    | °C    |
|   | Soldering Temperature, for 10 seconds (1.6mm from case)           | 300                |       |
|   | Mounting Torque, 6-32 or M3 screw                                 | 10 lbf•in (1.1N•m) |       |
| <b>Thermal Re</b>                       | sistance  |                    |       |

|                     | Parameter                           | Тур. | Max. | Units |
|---------------------|-------------------------------------|------|------|-------|
| $R_{\theta JC}$     | Junction-to-Case ®                  |      | 0.75 |       |
| $R_{\theta CS}$     | Case-to-Sink, Flat, Greased Surface | 0.50 |      | °C/W  |
| $R_{	ext{	heta}JA}$ | Junction-to-Ambient                 |      | 62   |       |

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<sup>\*</sup>Qualification standards can be found at http://www.irf.com/

|                                   | Parameter                                    | Min.      | Тур.      | Max.    | Units    | Conditions  |  |
|-----------------------------------|--|-----------|-----------|---------|----------|---|--|
| V <sub>(BR)DSS</sub>              | Drain-to-Source Breakdown Voltage            | 55        |           |         | V        | $V_{GS} = 0V, I_D = 250 \mu A$                                      |  |
| $\Delta V_{(BR)DSS} / \Delta T_J$ | Breakdown Voltage Temp. Coefficient          |           | 0.057     |         | V/°C     | Reference to 25°C, I <sub>D</sub> = 1mA                             |  |
| R <sub>DS(on)</sub>               | Static Drain-to-Source On-Resistance         |           |           | 8.0     | mΩ       | V <sub>GS</sub> = 10V, I <sub>D</sub> = 62A ④                       |  |
| V <sub>GS(th)</sub>               | Gate Threshold Voltage                       | 2.0       |           | 4.0     | V        | $V_{DS} = V_{GS}, I_D = 250 \mu A$                                  |  |
| gfs                               | Forward Transconductance                     | 44        |           |         | S        | V <sub>DS</sub> = 25V, I <sub>D</sub> = 62A ④                       |  |
| I <sub>DSS</sub>                  | Drain-to-Source Leakage Current              | _         |           | 25      | μA       | $V_{DS} = 55V, V_{GS} = 0V$   |  |
|                                   |  |           |           | 250     |          | $V_{DS} = 44V, V_{GS} = 0V, T_{J} = 150^{\circ}C$                   |  |
| I <sub>GSS</sub>                  | Gate-to-Source Forward Leakage               |           |           | 100     | nA       | $V_{GS} = 20V$  |  |
|                                   | Gate-to-Source Reverse Leakage               |           |           | -100    |          | V <sub>GS</sub> = -20V  |  |
| Dynamic E                         | lectrical Characteristics @ T <sub>J</sub> = | = 25°C    | (unle     | ss otł  | nerwis   | e specified)  |  |
|                                   | Parameter                                    | Min.      | Тур.      | Max.    | Units    | Conditions  |  |
| Q <sub>g</sub>                    | Total Gate Charge                            |           |           | 146     |          | I <sub>D</sub> = 62A  |  |
| Q <sub>gs</sub>                   | Gate-to-Source Charge                        |           |           | 35      | nC       | $V_{DS} = 44V$  |  |
| Q <sub>gd</sub>                   | Gate-to-Drain ("Miller") Charge              |           |           | 54      |          | V <sub>GS</sub> = 10V, See Fig. 6 & 13 ④                            |  |
| t <sub>d(on)</sub>                | Turn-On Delay Time                           |           | 14        |         |          | $V_{DD} = 28V$  |  |
| t <sub>r</sub>                    | Rise Time                                    |           | 101       |         | 1        | I <sub>D</sub> = 62A  |  |
| t <sub>d(off)</sub>               | Turn-Off Delay Time                          |           | 50        |         | ns       | $R_{G} = 4.5 \Omega$  |  |
| t <sub>f</sub>                    | Fall Time                                    |           | 65        | _       |          | $V_{GS}$ = 10V, See Fig. 10 $\circledast$                           |  |
| L <sub>D</sub>                    | Internal Drain Inductance                    |           | 4.5       |         |          | Between lead,   |  |
|                                   |  |           |           |         | nH       | 6mm (0.25in.)   |  |
| Ls                                | Internal Source Inductance                   | -         | 7.5       |         |          | from package  |  |
|                                   |  |           |           |         |          | and center of die contact   |  |
| C <sub>iss</sub>                  | Input Capacitance                            |           | 3247      |         |          | $V_{GS} = 0V$   |  |
| C <sub>oss</sub>                  | Output Capacitance                           |           | 781       | _       | pF       | $V_{DS} = 25V$  |  |
| C <sub>rss</sub>                  | Reverse Transfer Capacitance                 |           | 211       |         |          | f = 1.0MHz, See Fig. 5  |  |
| <b>Diode Cha</b>                  | aracteristics                                |           |           |         |          |   |  |
|                                   | Parameter                                    | Min.      | Тур.      | Max.    | Units    | Conditions  |  |
| I <sub>S</sub>                    | Continuous Source Current                    |           |           | 110     |          | MOSFET symbol   |  |
|                                   | (Body Diode)                                 |           |           |         | А        | showing the   |  |
| I <sub>SM</sub>                   | Pulsed Source Current                        |           |           | 390     |          | integral reverse  |  |
|                                   | (Body Diode) ①                               |           |           |         |          | p-n junction diode.   |  |
| V <sub>SD</sub>                   | Diode Forward Voltage                        |           |           | 1.3     | V        | T <sub>J</sub> = 25°C, I <sub>S</sub> = 62A, V <sub>GS</sub> = 0V ④ |  |
| t <sub>rr</sub>                   | Reverse Recovery Time                        |           | 69        | 104     | ns       | T <sub>J</sub> = 25°C, I <sub>F</sub> = 62A                         |  |
| Q <sub>rr</sub>                   | Reverse Recovery Charge                      |           | 143       | 215     | nC       | di/dt = 100A/µs ④   |  |
| t <sub>on</sub>                   | Forward Turn-On Time                         | Intrinsio | c turn-or | time is | negligib | le (turn-on is dominated by LS+LD)                                  |  |
|                                   |  |           |           |         |          |   |  |

#### Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- 3 I\_{SD}  $\leq$  62A, di/dt  $\leq$  207A/µs, V\_{DD}  $\leq$  V\_{(BR)DSS}, T\_J  $\leq$  175°C.
- ④ Pulse width  $\leq$  400µs; duty cycle  $\leq$  2%.
- ⑤ Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 75A.
- This is a typical value at device destruction and represents operation outside rated limits.
- $\odot\,$  This is a calculated value limited to  $T_J$  = 175°C.
- $\ensuremath{\mathbb{B}}$  R<sub>heta</sub> is measured at T<sub>J</sub> of approximately 90°C.

### Qualification Information<sup>†</sup>

|               |                      | Automotive  |                                      |  |  |
|---------------|----------------------|---|--------------------------------------|--|--|
|               |                      | (per AEC-Q101) <sup>††</sup>  |                                      |  |  |
| Qualification | Level                | Comments: This part number(s) passed Automotive qualification.<br>IR's Industrial and Consumer qualification level is granted by<br>extension of the higher Automotive level. |                                      |  |  |
| Moisture Sen  | sitivity Level       | TO-220 N/A  |                                      |  |  |
| Machine Model |                      | Class M4 (+/- 600V) <sup>†††</sup>  |                                      |  |  |
|               |                      | AEC-Q101-002  |                                      |  |  |
| 500           | Human Body Model     |   | Class H1C (+/- 2000V) <sup>†††</sup> |  |  |
| ESD           |                      |   | AEC-Q101-001                         |  |  |
|               | Charged Device Model |   | Class C5 (+/- 2000V) <sup>†††</sup>  |  |  |
|               |                      |   | AEC-Q101-005                         |  |  |
| RoHS Compli   | ant                  | Yes   |                                      |  |  |

† Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

†† Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.

††† Highest passing voltage.



Fig 1. Typical Output Characteristics



Fig 2. Typical Output Characteristics



Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature



# Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage





#### Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

1000







Fig 10a. Switching Time Test Circuit



Fig 10b. Switching Time Waveforms



Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case



Fig 12a. Unclamped Inductive Test Circuit



Fig 12b. Unclamped Inductive Waveforms



Fig 13a. Basic Gate Charge Waveform



Fig 12c. Maximum Avalanche Energy Vs. Drain Current



Fig 13b. Gate Charge Test Circuit







\*  $V_{GS}$  = 5V for Logic Level Devices

#### Fig 14. For N-Channel HEXFETS

International **TOR** Rectifier

### **TO-220AB** Package Outline

Dimensions are shown in millimeters (inches)





NOTES:

- : DMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994. DMENSIONS ARE SHOWN IN INCHES [MILLIMETERS]. LEAD DMENSION AND FINISH UNCONTROLLED IN L1. DMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY. DMENSION D & c1 APPLY TO BASE METAL ONLY. CONTROLLING DMENSION : INCHES. THERMAL PAD CONTOUR OPTIONAL WITHIN DMENSIONS E,H1,D2 & E1 DMENSION DE 2X H1 DEFINE A ZONE WHERE STAMPING AND SINGULATION IRREGULARTIES ARE ALLOWED.

- GATE - DRAIN - SOURCE 1,-2,-3,-IGBTs, CoPACK

LEAD ASSIGNMENTS

HEXFET

1.- GATE 2.- COLLECTOR 3.- EMITTER DIODES - ANODE/OPEN - CATHODE - ANODE 1.-2.-3.-

| SYMBOL | MILLIMETERS      |       | INCHES |                      | 1     |
|--------|------------------|-------|--------|----------------------|-------|
|        | MIN.             | MAX.  | MIN.   | MAX.                 | NOTES |
| A      | 3.56             | 4.82  | .140   | .190                 |       |
| A1     | 0.51             | 1.40  | .020   | .055                 |       |
| A2     | 2.04             | 2.92  | .080   | .115                 |       |
| b      | 0,38             | 1.01  | .015   | .040                 |       |
| b1     | 0.38             | 0.96  | .015   | .038                 | 5     |
| b2     | 1,15             | 1,77  | .045   | .070                 |       |
| b3     | 1.15             | 1.73  | .045   | .068                 |       |
| c      | 0.36             | 0.61  | .014   | .024                 |       |
| c1     | 0,36             | 0.56  | .014   | ,022                 | 5     |
| _      |                  |       |        |                      |       |
| D      | 14.22            | 16.51 | .560   | .650                 | 4     |
| D1     | 8.38             | 9.02  | .330   | .355                 | _     |
| D2     | 12.19            | 12.88 | .480   | .507                 | 7     |
| E      | 9,66             | 10.66 | .380   | .420                 | 4,7   |
| E1     | 8.38             | 8.89  | .330   | .350                 | 7     |
| e      | 2.54 BSC<br>5.08 |       | .100   | .100 BSC<br>.200 BSC |       |
| e1     |                  |       |        |                      | 1     |
| H1     | 5.85             | 6.55  | .230   | .270                 | 7,8   |
| L      | 12.70            | 14,73 | .500   | .580                 |       |
| L1     |                  | 6.35  | -      | .250                 | 3     |
| øP     | 3.54             | 4.08  | .139   | .161                 |       |
| 0      | 2,54             | 3.42  | ,100   | ,135                 | 1     |
| ø      | 90               | -95   | 90*    | -93                  | -     |
|        |                  |       | 1      |                      |       |

**TO-220AB Part Marking Information** 



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

### **Ordering Information**

| Base part<br>number | Package Type | Standard Pack |          | Complete Part Number |
|---------------------|--------------|---------------|----------|----------------------|
|                     |              | Form          | Quantity |                      |
| AUIRF3205           | TO-220       | Tube          | 50       | AUIRF3205            |

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